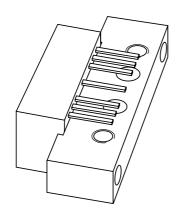
# DATA SHEET



## **BGY887** 860 MHz, 21.5 dB gain push-pull amplifier

Product specification Supersedes data of 1999 Mar 30 2001 Nov 15





### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

#### **FEATURES**

- · Excellent linearity
- · Extremely low noise
- Excellent return loss properties
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability.

### **APPLICATIONS**

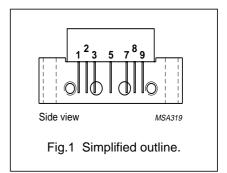
 CATV systems operating in the 40 to 860 MHz frequency range.

### **DESCRIPTION**

Hybrid dynamic range amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC).

#### **PINNING - SOT115J**

PIN	DESCRIPTION	
1	input	
2	common	
3	common	
5	+V <sub>B</sub>	
7	common	
8	common	
9	output	



### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G <sub>p</sub>	power gain	f = 50 MHz	21	22	dB
		f = 860 MHz	21.5	_	dB
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	_	235	mA

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER		MAX.	UNIT
Vi	RF input voltage		65	dBmV
T <sub>stg</sub>	storage temperature		+100	°C
T <sub>mb</sub>	operating mounting base temperature	-20	+100	°C

### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

#### **CHARACTERISTICS**

**Table 1** Bandwidth 40 to 860 MHz;  $V_B = 24 \text{ V}$ ;  $T_{case} = 30 \,^{\circ}\text{C}$ ;  $Z_S = Z_L = 75 \,^{\circ}\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	21	21.5	22	dB
·		f = 860 MHz	21.5	22.5	_	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.2	1	2	dB
FL	flatness of frequency response	f = 40 to 860 MHz	_	±0.2	±0.3	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	29.5	_	dB
		f = 80 to 160 MHz	18.5	27.5	_	dB
		f = 160 to 320 MHz	17	23	_	dB
		f = 320 to 640 MHz	15.5	22	_	dB
		f = 640 to 860 MHz	14	20	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	27	_	dB
		f = 80 to 160 MHz	18.5	25	_	dB
		f = 160 to 320 MHz	17	20.5	_	dB
		f = 320 to 640 MHz	15.5	19	_	dB
		f = 640 to 860 MHz	14	19	_	dB
S <sub>21</sub>	phase response	f = 50 MHz	-45	_	+45	deg
СТВ	composite triple beat	49 channels flat; V <sub>o</sub> = 44 dBmV; measured at 859.25 MHz	_	-64.5	-62	dB
X <sub>mod</sub>	cross modulation	49 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 55.25 MHz	_	-64.5	-61	dB
CSO	composite second order distortion	49 channels flat; V <sub>o</sub> = 44 dBmV; measured at 860.5 MHz	_	-67.5	-61	dB
d <sub>2</sub>	second order distortion	note 1	_	-77	-70	dB
Vo	output voltage	d <sub>im</sub> = -60 dB; note 2	59	60.5	_	dBmV
F	noise figure	f = 50 MHz	_	4	4.5	dB
		f = 550 MHz	_	_	5	dB
		f = 600 MHz	_	_	5	dB
		f = 650 MHz	_	_	5	dB
		f = 750 MHz	_	-	5.5	dB
		f = 860 MHz	_	5	6.5	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	220	235	mA

### **Notes**

- 1.  $f_p = 55.25 \text{ MHz}$ ;  $V_p = 44 \text{ dBmV}$ ;  $f_q = 805.25 \text{ MHz}$ ;  $V_q = 44 \text{ dBmV}$ ; measured at  $f_p + f_q = 860.5 \text{ MHz}$ .
- 2. Measured according to DIN45004B:

 $f_p = 851.25 \text{ MHz}; V_p = V_o;$ 

 $f_q = 858.25 \text{ MHz}; V_q = V_o - 6 \text{ dB};$ 

 $f_r = 860.25 \text{ MHz}; V_r = V_o - 6 \text{ dB};$ 

measured at  $f_p + f_q - f_r = 849.25$  MHz.

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

**Table 2** Bandwidth 40 to 860 MHz;  $V_B = 24$  V;  $T_{case} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	21	21.5	22	dB
•		f = 860 MHz	21.5	22.5	_	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.2	1	2	dB
FL	flatness of frequency response	f = 40 to 860 MHz	_	±0.2	±0.3	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	29.5	_	dB
		f = 80 to 160 MHz	18.5	27.5	_	dB
		f = 160 to 320 MHz	17	23	_	dB
		f = 320 to 640 MHz	15.5	22	_	dB
		f = 640 to 860 MHz	14	20	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	27	_	dB
		f = 80 to 160 MHz	18.5	25	_	dB
		f = 160 to 320 MHz	17	20.5	_	dB
		f = 320 to 640 MHz	15.5	19	_	dB
		f = 640 to 860 MHz	14	19	_	dB
S <sub>21</sub>	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	129 channels flat; V <sub>o</sub> = 42 dBmV; measured at 859.25 MHz	-	-54	-51	dB
X <sub>mod</sub>	cross modulation	129 channels flat; V <sub>o</sub> = 42 dBmV; measured at 55.25 MHz	-	-60	-57	dB
CSO	composite second order distortion	129 channels flat; $V_0 = 42 \text{ dBmV}$ ; measured at 860.5 MHz	_	-60.5	<b>-</b> 55	dB
d <sub>2</sub>	second order distortion	note 1	_	-77	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	59	60.5	_	dBmV
F	noise figure	see Table 1	_	_	_	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	220	235	mA

### **Notes**

```
1. f_p = 55.25 \text{ MHz}; V_p = 44 \text{ dBmV};

f_q = 805.25 \text{ MHz}; V_q = 44 \text{ dBmV};

measured at f_p + f_q = 860.5 \text{ MHz}.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 851.25 \text{ MHz; } V_p = V_o; \\ f_q &= 858.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 860.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 849.25 \text{ MHz.} \end{split}
```

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

### 860 MHz, 21.5 dB gain push-pull amplifier

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**Table 3** Bandwidth 40 to 750 MHz;  $V_B = 24$  V;  $T_{case} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G <sub>p</sub>	power gain	f = 50 MHz	21	21.5	22	dB
•		f = 750 MHz	21.5	22.3	-	dB
SL	slope cable equivalent	f = 40 to 750 MHz	0.2	_	2	dB
FL	flatness of frequency response	f = 40 to 750 MHz	_	-	±0.3	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	29.5	-	dB
		f = 80 to 160 MHz	18.5	27.5	-	dB
		f = 160 to 320 MHz	17	23	-	dB
		f = 320 to 640 MHz	15.5	22	-	dB
		f = 640 to 750 MHz	14	20	-	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	27	_	dB
		f = 80 to 160 MHz	18.5	25	-	dB
		f = 160 to 320 MHz	17	20.5	-	dB
		f = 320 to 640 MHz	15.5	19	_	dB
		f = 640 to 750 MHz	14	19	_	dB
S <sub>21</sub>	phase response	f = 50 MHz	-45	_	+45	deg
СТВ	composite triple beat	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 745.25 MHz	_	-53	<b>-51</b>	dB
X <sub>mod</sub>	cross modulation	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	-	-57	-54	dB
CSO	composite second order distortion	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 746.5 MHz	_	-62	-56	dB
d <sub>2</sub>	second order distortion	note 1	_	-78	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	60	62	-	dBmV
F	noise figure	see Table 1	_	_	-	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	220	235	mA

### **Notes**

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 691.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 746.5 MHz.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 740.25 \text{ MHz; } V_p = V_o; \\ f_q &= 747.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 749.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 738.25 \text{ MHz.} \end{split}
```

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

**Table 4** Bandwidth 40 to 600 MHz;  $V_B = 24$  V;  $T_{case} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	21	21.5	22	dB
		f = 600 MHz	21.5	22.1	_	dB
SL	slope cable equivalent	f = 40 to 600 MHz	0.2	_	2	dB
FL	flatness of frequency response	f = 40 to 600 MHz	_	_	±0.2	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	29.5	_	dB
		f = 80 to 160 MHz	18.5	27.5	_	dB
		f = 160 to 320 MHz	17	23	_	dB
		f = 320 to 600 MHz	16	22	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	27	_	dB
		f = 80 to 160 MHz	18.5	25	_	dB
		f = 160 to 320 MHz	17	20.5	_	dB
		f = 320 to 600 MHz	16	19	_	dB
S <sub>21</sub>	phase response	f = 50 MHz	-45	_	+45	deg
СТВ	composite triple beat	85 channels flat; V <sub>o</sub> = 44 dBmV; measured at 595.25 MHz	-	_	-56	dB
X <sub>mod</sub>	cross modulation	85 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	-	-	-57	dB
CSO	composite second order distortion	85 channels flat; V <sub>o</sub> = 44 dBmV; measured at 596.5 MHz	-	-	-58	dB
d <sub>2</sub>	second order distortion	note 1	_	_	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$ ; note 2	61	_	_	dBmV
F	noise figure	see Table 1	_	_	_	dB
I <sub>tot</sub>	total current consumption (DC)	note 3	_	220	235	mA

#### **Notes**

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 541.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 596.5 MHz.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 590.25 \text{ MHz; } V_p = V_o; \\ f_q &= 597.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 599.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 588.25 \text{ MHz.} \end{split}
```

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

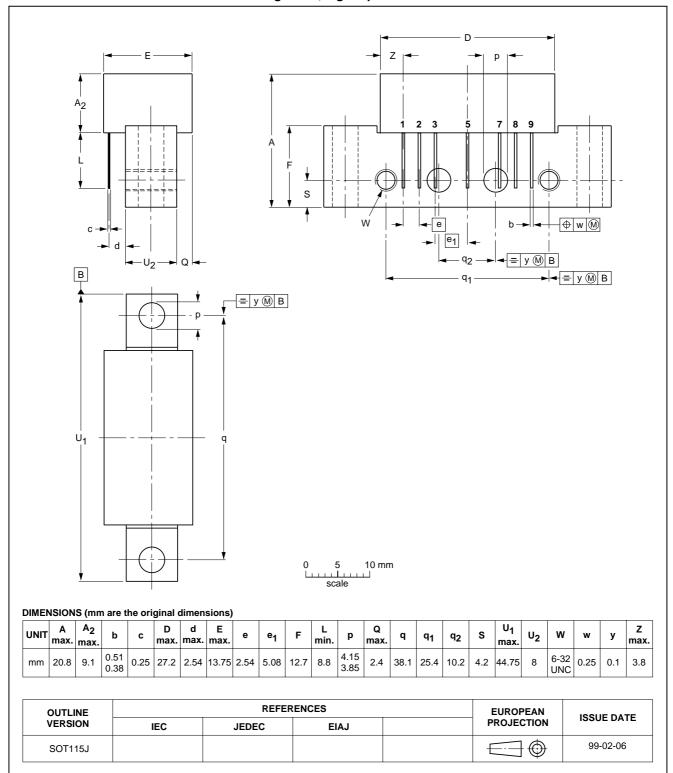
### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

#### **PACKAGE OUTLINE**

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

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### 860 MHz, 21.5 dB gain push-pull amplifier

**BGY887** 

NOTES

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#### **Contact information**

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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